E·XFL

XMOS - XS1-L8A-64-TQ48-I5 Datasheet



Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Product Status	Active
Core Processor	XCore
Core Size	32-Bit 8-Core
Speed	500MIPS
Connectivity	Configurable
Peripherals	-
Number of I/O	28
Program Memory Size	64KB (16K x 32)
Program Memory Type	SRAM
EEPROM Size	-
RAM Size	-
Voltage - Supply (Vcc/Vdd)	0.95V ~ 3.6V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-TQFP Exposed Pad
Supplier Device Package	48-TQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/xmos/xs1-l8a-64-tq48-i5

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

4 Signal Description

This section lists the signals and I/O pins available on the XS1-L8A-64-TQ48. The device provides a combination of 1 bit, 4bit, 8bit and 16bit ports, as well as wider ports that are fully or partially (gray) bonded out. All pins of a port provide either output or input, but signals in different directions cannot be mapped onto the same port.

Pins may have one or more of the following properties:

- PD/PU: The IO pin a weak pull-down or pull-up resistor. On GPIO pins this resistor can be enabled.
- ST: The IO pin has a Schmitt Trigger on its input.

	Power pins (4)										
Signal	Function	Туре	Properties								
GND	Digital ground	GND									
PLL_AVDD	Analog PLL power	PWR									
VDD	Digital tile power	PWR									
VDDIO	Digital I/O power	PWR									

Clocks pins (2)										
Signal	Function	Туре	Properties							
CLK	PLL reference clock	Input	PD, ST							
MODE[3:0]	Boot mode select	Input	PU, ST							

	JTAG pins (6)										
Signal	Function	Туре	Properties								
RST_N	Global reset input	Input	PU, ST								
ТСК	Test clock	Input	PU, ST								
TDI	Test data input	Input	PU, ST								
TDO	Test data output	Output	PD, OT								
TMS	Test mode select	Input	PU, ST								
TRST_N	Test reset input	Input	PU, ST								

	I/O pins (28)		
Signal	Function	Туре	Properties
X0D00	1A ⁰	I/O	PDs, Rs
X0D01	1B ⁰	I/0	PD _S , R _S
X0D10	1C ⁰	I/O	PD _S , R _S
X0D11	1D ⁰	I/0	PD _S , R _S
X0D12	1E ⁰	I/O	PD _S , R _U
X0D13	XLB ⁴ _{out} 1F ⁰	I/0	PDs, Ru
X0D14	XLB_{out}^3 4C ⁰ 8B ⁰ 16A ⁸ 32A ²⁸	I/O	PD _S , R _U
X0D15	XLB_{out}^2 4C ¹ 8B ¹ 16A ⁹ 32A ²⁹	I/O	PD _S , R _U

(continued)



5 Product Overview

The XS1-L8A-64-TQ48 is a powerful device that consists of a single xCORE Tile, which comprises a flexible logical processing cores with tightly integrated I/O and on-chip memory.

5.1 Logical cores

MIPS

400 MIPS

500 MIPS

Frequency

400 MHz

500 MHz

1

100

125

Speed

grade

4

5

The tile has 8 active logical cores, which issue instructions down a shared fourstage pipeline. Instructions from the active cores are issued round-robin. If up to four logical cores are active, each core is allocated a quarter of the processing cycles. If more than four logical cores are active, each core is allocated at least 1/ncycles (for *n* cores). Figure 2 shows the guaranteed core performance depending on the number of cores used.

2

100

125

3

100

125

Minimum MIPS per core (for *n* cores)

5

80

100

6

67

83

7

57

71

8

50

63

4

100

125

Figure 2: Logical core performance

There is no way that the performance of a logical core can be reduced below these predicted levels. Because cores may be delayed on I/O, however, their unused processing cycles can be taken by other cores. This means that for more than four logical cores, the performance of each core is often higher than the predicted minimum but cannot be guaranteed.

The logical cores are triggered by events instead of interrupts and run to completion. A logical core can be paused to wait for an event.

5.2 xTIME scheduler

The xTIME scheduler handles the events generated by xCORE Tile resources, such as channel ends, timers and I/O pins. It ensures that all events are serviced and synchronized, without the need for an RTOS. Events that occur at the I/O pins are handled by the Hardware-Response ports and fed directly to the appropriate xCORE Tile. An xCORE Tile can also choose to wait for a specified time to elapse, or for data to become available on a channel.

Tasks do not need to be prioritised as each of them runs on their own logical xCORE. It is possible to share a set of low priority tasks on a single core using cooperative multitasking.

5.3 Hardware Response Ports

Hardware Response ports connect an xCORE tile to one or more physical pins and as such define the interface between hardware attached to the XS1-L8A-64-TQ48, and the software running on it. A combination of 1 bit, 4 bit, 8 bit, 16 bit and 32 bit ports are available. All pins of a port provide either output or input. Signals in different directions cannot be mapped onto the same port.



In many cases I/O signals are accompanied by strobing signals. The xCORE ports can input and interpret strobe (known as readyIn and readyOut) signals generated by external sources, and ports can generate strobe signals to accompany output data.

On reset, each port is connected to clock block 0, which runs from the xCORE Tile reference clock.

5.5 Channels and Channel Ends

Logical cores communicate using point-to-point connections, formed between two channel ends. A channel-end is a resource on an xCORE tile, that is allocated by the program. Each channel-end has a unique system-wide identifier that comprises a unique number and their tile identifier. Data is transmitted to a channel-end by an output-instruction; and the other side executes an input-instruction. Data can be passed synchronously or asynchronously between the channel ends.

5.6 xCONNECT Switch and Links

XMOS devices provide a scalable architecture, where multiple xCORE devices can be connected together to form one system. Each xCORE device has an xCONNECT interconnect that provides a communication infrastructure for all tasks that run on the various xCORE tiles on the system.

The interconnect relies on a collection of switches and XMOS links. Each xCORE device has an on-chip switch that can set up circuits or route data. The switches are connected by xConnect Links. An XMOS link provides a physical connection between two switches. The switch has a routing algorithm that supports many different topologies, including lines, meshes, trees, and hypercubes.

The links operate in either 2 wires per direction or 5 wires per direction mode, depending on the amount of bandwidth required. Circuit switched, streaming and packet switched data can both be supported efficiently. Streams provide the fastest possible data rates between xCORE Tiles (up to 250 MBit/s), but each stream requires a single link to be reserved between switches on two tiles. All packet communications can be multiplexed onto a single link.



10

OD, *F* and *R* must be chosen so that $0 \le R \le 63$, $0 \le F \le 4095$, $0 \le OD \le 7$, and $260MHz \le F_{osc} \times \frac{F+1}{2} \times \frac{1}{R+1} \le 1.3GHz$. The *OD*, *F*, and *R* values can be modified by writing to the digital node PLL configuration register.

The MODE pins must be held at a static value during and after deassertion of the system reset.

If a different tile frequency is required (eg, 500 MHz), then the PLL must be reprogrammed after boot to provide the required tile frequency. The XMOS tools perform this operation by default. Further details on configuring the clock can be found in the XS1-L Clock Frequency Control document, X1433.

7 Boot Procedure

The device is kept in reset by driving RST_N low. When in reset, all GPIO pins are high impedance. When the device is taken out of reset by releasing RST_N the processor starts its internal reset process. After 15-150 μ s (depending on the input clock), all GPIO pins have their internal pull-resistor enabled, and the processor boots at a clock speed that depends on MODE0 and MODE1.

The xCORE Tile boot procedure is illustrated in Figure 7. In normal usage, MODE[3:2] controls the boot source according to the table in Figure 8. If bit 5 of the security register (*see* §8.1) is set, the device boots from OTP.



The boot image has the following format:

XS1-L8A-64-TQ48



The boundary scan TAP is a standard 1149.1 compliant TAP that can be used for boundary scan of the I/O pins. The chip TAP provides access into the xCORE Tile, switch and OTP for loading code and debugging.

The TRST_N pin must be asserted low during and after power up for 100 ns. If JTAG is not required, the TRST_N pin can be tied to ground to hold the JTAG module in reset.

The JTAG device identification register can be read by using the IDCODE instruction. Its contents are specified in Figure 12.

Figure 12: IDCODE return value

Bit31 Device Identification Register													В	it0																		
2:	Z: Version Part Number Ma											Manufacturer Identity							1													
JE JE	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	1	1	0	0	0	1	1	0	0	1	1
Je	0 0					0 0						Z	2		6				3				3									

The JTAG usercode register can be read by using the USERCODE instruction. Its contents are specified in Figure 13. The OTP User ID field is read from bits [22:31] of the security register , *see* §8.1 (all zero on unprogrammed devices).

Figure 13: USERCODE return value

	Bit31 Usercode Register														BitO																	
-		OTP User ID					Unused Silicon Revision																									
E n	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
2	0			()				0			Z	2	8			0			0				0								

10 Board Integration

The device has the following power supply pins:

-XM()S

- VDD pins for the xCORE Tile
- VDDIO pins for the I/O lines
- PLL_AVDD pins for the PLL

Several pins of each type are provided to minimize the effect of inductance within the package, all of which must be connected. The power supplies must be brought up monotonically and input voltages must not exceed specification at any time.

The VDD supply must ramp from 0V to its final value within 10 ms to ensure correct startup.

The VDDIO supply must ramp to its final value before VDD reaches 0.4 V.

The PLL_AVDD supply should be separated from the other noisier supplies on the board. The PLL requires a very clean power supply, and a low pass filter (for example, a 4.7Ω resistor and 100 nF multi-layer ceramic capacitor) is recommended on this pin.

The following ground pins are provided:

► GND for all supplies

All ground pins must be connected directly to the board ground.

The VDD and VDDIO supplies should be decoupled close to the chip by several 100 nF low inductance multi-layer ceramic capacitors between the supplies and GND (for example, 4x100nF 0402 low inductance MLCCs per supply rail). The ground side of the decoupling capacitors should have as short a path back to the GND pins as possible. A bulk decoupling capacitor of at least 10 uF should be placed on each of these supplies.

RST_N is an active-low asynchronous-assertion global reset signal. Following a reset, the PLL re-establishes lock after which the device boots up according to the boot mode (*see* §7). RST_N and must be asserted low during and after power up for 100 ns.

10.1 Land patterns and solder stencils

The land pattern recommendations in this document are based on a RoHS compliant process and derived, where possible, from the nominal *Generic Requirements for Surface Mount Design and Land Pattern Standards* IPC-7351B specifications. This standard aims to achieve desired targets of heel, toe and side fillets for solderjoints.

Solder paste and ground via recommendations are based on our engineering and development kit board production. They have been found to work and optimized as appropriate to achieve a high yield. The size, type and number of vias used in the center pad affects how much solder wicks down the vias during reflow. This in turn, along with solder paster coverage, affects the final assembled package height. These factors should be taken into account during design and manufacturing of the PCB.

The following land patterns and solder paste contains recommendations. Final land pattern and solder paste decisions are the responsibility of the customer. These should be tuned during manufacture to suit the manufacturing process.

-XM()S

17



-XMOS

XS1-L8A-64-TQ48

12 Package Information

TOP PACKAGE



NOTES:

- 1. All dimensions in millimeters.
- 2. Dimension tolerances shall be ± 0.05 mm
- unless otherwise specified. 3. Foot length 'L' is measured at gage plane
- 0.25mm above seating plane. 4. Dimension D1 and E1 are bottom package width
- and length and are measured at datum plane H. 5. Leadframe material: Eftec 64T Cu (or equivalent),

-XMOS

0.127mm (0.005") thick.



	LEAD	COUNT	48L			
	DIMS.	TOL.	1.0 mm THICK			
SEAT HEIGHT	A	MAX.	1.20			
STAND OFF	Α1	±0.05	0.10			
PACKAGE THICKNESS	Ag	±0.05	1.00			
O.D.WIDTH	D	±0.20	9.00			
PACKAGE WIDTH	D1	±0.10	7.00			
O.D LENGTH	E	±0.20	9.00			
PACKAGE LENGTH	E1	±0.10	7.00			
FOOT LENGTH	L	+0.15/-0.10	0.60			
HALF FOOTPRINT	Lı	REF	1.00			
LEAD PITCH	e	TYPE	0.50			
LEAD WIDTH	b	±0.05	0.22			
FOOT ANGLE	θ		0'-7'			
VERTICAL ANGLE	θ1		0° MIN.			
	θ2	±1*	12			
FIRST BEND	R	TYP	0.15			
SECOND BEND	R1	±0.05	0.15			
	aaa	MAX.	0.08			
COPLANARITY	ccc	MAX.	0.08			
	JEDEC REFERE	ENCE DRAWING	MS-026			
	VARIATION DES	SIGNATOR	ABC			

12.1 Part Marking



13 Ordering Information

	Product Code	Marking	Qualification	Speed Grade
	XS1-L8A-64-TQ48-C4	8L6C4	Commercial	400 MIPS
Figure 26:	XS1-L8A-64-TQ48-C5	8L6C5	Commercial	500 MIPS
Orderable	XS1-L8A-64-TQ48-I4	8L6I4	Industrial	400 MIPS
part numbers	XS1-L8A-64-TQ48-I5	8L6I5	Industrial	500 MIPS

-XMOS

XS1-L8A-64-TQ48

Appendices

Figure 27: Registers

A Configuration of the XS1



The device is configured through three banks of registers, as shown in Figure 27.

The following communication sequences specify how to access those registers. Any messages transmitted contain the most significant 24 bits of the channel-end to which a response is to be sent. This comprises the node-identifier and the channel number within the node. if no response is required on a write operation, supply 24-bits with the last 8-bits set, which suppresses the reply message. Any multi-byte data is sent most significant byte first.

A.1 Accessing a processor status register

The processor status registers are accessed directly from the processor instruction set. The instructions GETPS and SETPS read and write a word. The register number should be translated into a processor-status resource identifier by shifting the register number left 8 places, and ORing it with 0x0C. Alternatively, the functions getps(reg) and setps(reg,value) can be used from XC.

A.2 Accessing an xCORE Tile configuration register

xCORE Tile configuration registers can be accessed through the interconnect using the functions write_tile_config_reg(tileref, ...) and read_tile_config_reg(tile \rightarrow ref, ...), where tileref is the name of the xCORE Tile, e.g. tile[1]. These functions implement the protocols described below.

Instead of using the functions above, a channel-end can be allocated to communicate with the xCORE tile configuration registers. The destination of the channel-end should be set to 0xnnnnC20C where nnnnn is the tile-identifier.

A write message comprises the following:

control-token	24-bit response	16-bit	32-bit	control-token
192	channel-end identifier	register number	data	1

-XM()S

26

B.8 Ring Oscillator Value: 0x08

This register contains the current count of the xCORE Tile Wire ring oscillator. This value is not reset on a system reset.

0x08: Ring Oscillator Value

Bits	Perm	Init	Description
31:16	RO	-	Reserved
15:0	RO	-	Ring oscillator counter data.

B.9 Ring Oscillator Value: 0x09

This register contains the current count of the Peripheral Cell ring oscillator. This value is not reset on a system reset.

0x09 Ring Oscillator Value

:	Bits	Perm	Init	Description
-	31:16	RO	-	Reserved
2	15:0	RO	-	Ring oscillator counter data.

B.10 Ring Oscillator Value: 0x0A

This register contains the current count of the Peripheral Wire ring oscillator. This value is not reset on a system reset.

0x0A: Ring Oscillator Value

A:	Bits	Perm	Init	Description
9 or	31:16	RO	-	Reserved
e	15:0	RO	-	Ring oscillator counter data.

B.11 Debug SSR: 0x10

This register contains the value of the SSR register when the debugger was called.

0x10:	Bits	Perm	Init	Description
Debug SSR	31:0	RO	-	Reserved

B.12 Debug SPC: 0x11

This register contains the value of the SPC register when the debugger was called.

XS1-L8A-64-TQ48

Bits	Perm	Init	Description
31:18	RO	-	Reserved
17:16	DRW		If the debug interrupt was caused by a hardware breakpoint or hardware watchpoint, this field contains the number of the breakpoint or watchpoint. If multiple breakpoints or watch- points trigger at once, the lowest number is taken.
15:8	DRW		If the debug interrupt was caused by a logical core, this field contains the number of that core. Otherwise this field is 0.
7:3	RO	-	Reserved
2:0	DRW	0	Indicates the cause of the debug interrupt 1: Host initiated a debug interrupt through JTAG 2: Program executed a DCALL instruction 3: Instruction breakpoint 4: Data watch point 5: Resource watch point

0x15: Debug interrupt type

B.17 Debug interrupt data: 0x16

On a data watchpoint, this register contains the effective address of the memory operation that triggered the debugger. On a resource watchpoint, it countains the resource identifier.

0x16 Debug interrupt data

ox16: ebug	Bits	Perm	Init	Description
data	31:0	DRW		Value.

B.18 Debug core control: 0x18

This register enables the debugger to temporarily disable logical cores. When returning from the debug interrupts, the cores set in this register will not execute. This enables single stepping to be implemented.

0x18: Debug core control

Bits	Perm	Init	Description
31:8	RO	-	Reserved
7:0	DRW		1-hot vector defining which logical cores are stopped when not in debug mode. Every bit which is set prevents the respective logical core from running.

0x50 .. 0x53: Data watchpoint address 1

Data point	Bits	Perm	Init	Description
ess 1	31:0	DRW		Value.

B.23 Data watchpoint address 2: 0x60 .. 0x63

This set of registers contains the second address for the four data watchpoints.

0x60 .. 0x63: Data watchpoint address 2

a It	Bits	Perm	Init	Description
2	31:0	DRW		Value.

B.24 Data breakpoint control register: 0x70 .. 0x73

This set of registers controls each of the four data watchpoints.

	Bits	Perm	Init	Description
	31:24	RO	-	Reserved
	23:16	DRW	0	A bit for each logical core in the tile allowing the breakpoint to be enabled individually for each logical core.
	15:3	RO	-	Reserved
3: a ot	2	DRW	0	Set to 1 to enable breakpoints to be triggered on loads. Break- points always trigger on stores.
	1	DRW	0	By default, data watchpoints trigger if memory in the range [Address1Address2] is accessed (the range is inclusive of Address1 and Address2). If set to 1, data watchpoints trigger if memory outside the range (Address2Address1) is accessed (the range is exclusive of Address2 and Address1).
er	0	DRW	0	When 1 the instruction breakpoint is enabled.

0x70 .. 0x73: Data breakpoint control register

B.25 Resources breakpoint mask: 0x80 .. 0x83

This set of registers contains the mask for the four resource watchpoints.

-XMOS[®]

0x04: Control PSwitch permissions to debug registers

Bits	Perm	Init	Description
31:1	RO	-	Reserved
0	CRW		Set to 1 to restrict PSwitch access to all CRW marked registers to become read-only rather than read-write.

C.5 Cause debug interrupts: 0x05

This register can be used to raise a debug interrupt in this xCORE tile.

0x05: Cause debug interrupts

Bits	Perm	Init	Description
31:2	RO	-	Reserved
1	RO	0	Set to 1 when the processor is in debug mode.
0	CRW	0	Set to 1 to request a debug interrupt on the processor.

C.6 xCORE Tile clock divider: 0x06

This register contains the value used to divide the PLL clock to create the xCORE tile clock. The divider is enabled under control of the tile control register

0x06: xCORE Tile clock divider

-	Bits	Perm	Init	Description
2	31:8	RO	-	Reserved
r	7:0	RW		Value of the clock divider minus one.

C.7 Security configuration: 0x07

Copy of the security register as read from OTP.

0x07: Security configuration

ity	Bits	Perm	Init	Description
on	31:0	RO		Value.

C.8 PLink status: 0x10 .. 0x13

Status of each of the four processor links; connecting the xCORE tile to the switch.

Bits	Perm	Init	Description
31:26	RO	-	Reserved
25:24	RO		00 - ChannelEnd, 01 - ERROR, 10 - PSCTL, 11 - Idle.
23:16	RO		Based on SRC_TARGET_TYPE value, it represents channelEnd ID or Idle status.
15:6	RO	-	Reserved
5:4	RO		Two-bit network identifier
3	RO	-	Reserved
2	RO		1 when the current packet is considered junk and will be thrown away.
1	RO	0	Set to 1 if the switch is routing data into the link, and if a route exists from another link.
0	RO	0	Set to 1 if the link is routing data into the switch, and if a route is created to another link on the switch.

0x10 .. 0x13: PLink status

C.9 Debug scratch: 0x20 .. 0x27

A set of registers used by the debug ROM to communicate with an external debugger, for example over the switch. This is the same set of registers as the Debug Scratch registers in the processor status.

0x20 .. 0x27 Debug scratch

Debug	Bits	Perm	Init	Description
scratch	31:0	CRW		Value.

C.10 PC of logical core 0: 0x40

Value of the PC of logical core 0.

0x40 PC of logical core 0

ıl	Bits	Perm	Init	Description
0	31:0	RO		Value.

C.11 PC of logical core 1: 0x41

Init

0x41:
PC of logical
core 1BitsPerm31:0RO

C.12 PC of logical core 2: 0x42

Description

Value.

0x42: PC of logical	Bits	Perm	Init	Description
core 2	31:0	RO		Value.

C.13 PC of logical core 3: 0x43

0x42				
PC of logical	Bits	Perm	Init	Description
core 3	31:0	RO		Value.

C.14 PC of logical core 4: 0x44

0x44: PC of logical core 4

Bits

31:0

Perm	Init	Description
RO		Value.

C.15 PC of logical core 5: 0x45

0x45				
PC of logical	Bits	Perm	Init	Description
core 5	31:0	RO		Value.

Bits

31:0

Bits

31:0

C.16 PC of logical core 6: 0x46

0x46: PC of logical core 6

 Perm
 Init
 Description

 RO
 Value.

C.17 PC of logical core 7: 0x47

0x47: PC of logical core 7

Bits	Perm	Init	Description
31:0	RO		Value.

C.18 SR of logical core 0: 0x60

Value of the SR of logical core 0

0x60: SR of logical core 0

Perm	Init	Description
RO		Value.

C.19 SR of logical core 1: 0x61

0x61: SR of logical core 1

1: al	Bits	Perm	Init	Description
1	31:0	RO		Value.

C.20 SR of logical core 2: 0x62

0x62: SR of logical core 2

Bits	Perm	Init	Description
31:0	RO		Value.

-**X**M(

Bits	Perm	Init	Description
31:28	RW	0	The direction for packets whose first mismatching bit is 7.
27:24	RW	0	The direction for packets whose first mismatching bit is 6.
23:20	RW	0	The direction for packets whose first mismatching bit is 5.
19:16	RW	0	The direction for packets whose first mismatching bit is 4.
15:12	RW	0	The direction for packets whose first mismatching bit is 3.
11:8	RW	0	The direction for packets whose first mismatching bit is 2.
7:4	RW	0	The direction for packets whose first mismatching bit is 1.
3:0	RW	0	The direction for packets whose first mismatching bit is 0.

0x0C: Directions 0-7

D.9 Directions 8-15: 0x0D

This register contains eight directions, for packets with a mismatch in bits 15..8 of the node-identifier. The direction in which a packet will be routed is goverened by the most significant mismatching bit.

Bits	Perm	Init	Description
31:28	RW	0	The direction for packets whose first mismatching bit is 15.
27:24	RW	0	The direction for packets whose first mismatching bit is 14.
23:20	RW	0	The direction for packets whose first mismatching bit is 13.
19:16	RW	0	The direction for packets whose first mismatching bit is 12.
15:12	RW	0	The direction for packets whose first mismatching bit is 11.
11:8	RW	0	The direction for packets whose first mismatching bit is 10.
7:4	RW	0	The direction for packets whose first mismatching bit is 9.
3:0	RW	0	The direction for packets whose first mismatching bit is 8.

0x0D: Directions 8-15

D.10 DEBUG_N configuration: 0x10

Configures the behavior of the DEBUG_N pin.

	Bits	Perm	Init	Description
	31:2	RO	-	Reserved
):	1	RW	0	Set to 1 to enable signals on DEBUG_N to generate DCALL on the core.
N N	0	RW	0	When set to 1, the DEBUG_N wire will be pulled down when the node enters debug mode.

0x10 DEBUG_N configuration

D.13 PLink status and network: 0x40 .. 0x43

These registers contain status information and the network number that each processor-link belongs to.

Bits	Perm	Init	Description
31:26	RO	-	Reserved
25:24	RO		If this link is currently routing data into the switch, this field specifies the type of link that the data is routed to: 0: plink 1: external link 2: internal control link
23:16	RO	0	If the link is routing data into the switch, this field specifies the destination link number to which all tokens are sent.
15:6	RO	-	Reserved
5:4	RW	0	Determines the network to which this link belongs, set for quality of service.
3	RO	-	Reserved
2	RO	0	Set to 1 if the current packet is junk and being thrown away. A packet is considered junk if, for example, it is not routable.
1	RO	0	Set to 1 if the switch is routing data into the link, and if a route exists from another link.
0	RO	0	Set to 1 if the link is routing data into the switch, and if a route is created to another link on the switch.

0x40 .. 0x43: PLink status and network

D.14 Link configuration and initialization: 0x80 .. 0x87

-XMOS[®]

These registers contain configuration and debugging information specific to external links. The link speed and width can be set, the link can be initialized, and the link status can be monitored. The registers control links C, D, A, B, G, H, E, and F in that order.

L Revision History

Date	Description
2013-01-30	New datasheet - revised part numbering
2013-02-26	New multicore microcontroller introduction
	Moved configuration sections to appendices
2013-07-19	Updated Features list with available ports and links - Section 2
	Simplified link bits in Signal Description - Section 4
	New JTAG, xSCOPE and Debugging appendix - Section G
	New Schematics Design Check List - Section H
	New PCB Layout Design Check List - Section I
2013-12-09	Added Industrial Ambient Temperature - Section 11.1
2015-04-14	Updated Introduction - Section 1; Pin Configuration - Section 3; Signal Descrip- tion - Section 4

XMOS®

Copyright © 2015, All Rights Reserved.

X9681,

Xmos Ltd. is the owner or licensee of this design, code, or Information (collectively, the "Information") and is providing it to you "AS IS" with no warranty of any kind, express or implied and shall have no liability in relation to its use. Xmos Ltd. makes no representation that the Information, or any particular implementation thereof, is or will be free from any claims of infringement and again, shall have no liability in relation to any such claims.